INTERNATIONAL STANDARD

IEC 60115-9

First edition 2003-10

Fixed resistors for use in electronic equipment -

Part 9:
Sectional specification:
Fixed surface mount resistor networks
with individually measurable resistors

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INTERNATIONAL ELECTROTECHNICAL COMMISSION

FIXED RESISTORS FOR USE IN ELECTRONIC EQUIPMENT -

Part 9: Sectional specification: Fixed surface mount resistor networks with individually measurable resistors

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International Standard IEC 60115-9 has been prepared by IEC technical committee 40: Capacitors and resistors for electronic equipment.

The text of this standard is based on the following documents:

FDIS	Report on voting
40/1344/FDIS	40/1366/RVD

Full information on the voting for the approval of this standard can be found in the report on voting indicated in the above table.

This publication has been drafted in accordance with the ISO/IEC Directives, Part 2.

The committee has decided that the contents of this publication will remain unchanged until 2008. At this date, the publication will be

- · reconfirmed;
- withdrawn;
- replaced by a revised edition, or
- amended.

A bilingual edition of this standard may be issued at a later date.

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FIXED RESISTORS FOR USE IN ELECTRONIC EQUIPMENT -

Part 9: Sectional specification: Fixed surface mount resistor networks with individually measurable resistors

1 General

1.1 Scope

This part of IEC 60115 is applicable to fixed surface mount resistor networks with individually measurable resistors for use in electronic equipment.

1.2 Object

The object of this standard is to prescribe preferred ratings and characteristics and to select from IEC 60115-1, the appropriate Quality Assessment procedures, tests and measuring methods and to give general performance requirements for this type of resistor.

Test severities and requirements prescribed in detail specifications referring to this sectional specification must be of equal or higher performance level, because lower performance levels are not permitted.

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1.3 Normative references

The following referenced documents are indispensable for the application of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

IEC 60063:1963, Preferred number series for resistors and capacitors Amendment 1 (1967) Amendment 2 (1977)

IEC 60068-1: Environmental testing – Part 1: General and guidance

IEC 60068-2-1: Environmental testing - Part 2: Tests. Tests A: Cold

IEC 60068-2-2: Environmental testing – Part 2: Tests. Tests B: Dry heat

IEC 60115-1:1999, Fixed resistors for use in electronic equipment – Part 1: Generic specification

1.4 Information to be given in a detail specification

Detail specifications shall be derived from the relevant blank detail specification.

Detail specifications shall not specify requirements inferior to those of the generic, sectional specification or blank detail specification.

When more severe requirements are included, they shall be listed in 1.8 of the detail specification and indicated in the test schedules, for example by an asterisk.

The following information shall be given in each detail specification and the values quoted shall preferably be selected from those given in the appropriate clause of this sectional specification.

1.4.1 Outline drawing and dimensions

There shall be an illustration of the surface mount resistor network as an aid to easy recognition and for comparison of the surface mount resistor network with others.

Dimensions and their associated tolerances, which affect interchangeability and mounting, shall be given in the detail specification. All dimensions shall be stated in millimetres.

Normally the numerical values shall be given for the length, width and thickness of the body.

Schematic diagrams and pin identifications shall be given in the detail specification. Those are prescribed in Annex A.

Configurations of terminations shall be given in the detail specification. Those are prescribed in Annex B.

When the outline drawing is other than described above, the detail specification shall state such dimensional information as will adequately describe the surface mount resistor network.

1.4.2 Mounting iTeh STANDARD PREVIEW

The detail specification shall give guidance on methods of mounting for normal use. Mounting for test and measurement purposes (when required) shall be in accordance with 4.31 of IEC 60115-1.

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1.4.3 Style (2.2.2 of IEC 601 15-1) atcatalog/standards/sist/34021bb0-6f6f-4c36-830f-e1db3cf00644/iec-60115-9-2003

The styles given in Table 1 are preferred. All dimensions are in mm.

Table 1 - Style and outline dimensions

Dimensions in mm

Code	Length L	Width W	Thickness T	Diagram ^{a)}		uction of inals ^{a)}
1005X2	1 ± 0,1	1 ± 0,1	0,35 ± 0,1	А	Convex	
1005X4	2 ± 0,1	1 ± 0,1	0,4 ± 0,15	А	Convex	Concave
1608X2	1,6 ± 0,2	1,6 ± 0,2	0,55 ± 0,15	А	Convex	Concave
1608X4	3,2 ± 0,2	1,6 ± 0,2	0,55 ± 0,15	А	Convex	Concave
3216X4	5,08 ± 0,2	3,1 ± 0,2	0,55 ± 0,15	А	Convex	Concave
3216	3,2 ± 0,2	1,6 ± 0,2	0,5 ± 0,15	B, C	Convex	
4021	4 ± 0,2	2,1 ± 0,2	0,6 ± 0,15	D		Concave
6431	6,4 ± 0,2	3,1 ± 0,2	0,6 ± 0,15	B, C	Convex	Concave
6431			0,6 ± 0,15		Convex	Conca

Diagrams are shown in Annex A. Constructions of terminals are shown in Annex B.

1.4.4 Ratings and characteristics

The ratings and characteristics shall be in accordance with the relevant clauses of this specification together with the following:

Rated resistance range

See 2.2.1. The preferred values are those of the E-series of IEC 60063.

NOTE When products approved to the detail specification have different ranges, the following statement should be added:

"The range of values available in each style is given in the qualified products list".

1.4.5 Marking

The detail specification shall specify the content of the marking on the surface mount resistor network and on the package.

Surface mount resistor networks are generally not marked on the body. If some marking can be applied, the surface mount resistor network shall be clearly marked with the rated resistance and as many of the remaining items in 2.4 of IEC 60115-1 as possible.

All items shall be marked on the package. Deviations from the above mentioned requirements shall be specifically stated.

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2 Preferred ratings, characteristics and test severities

2.1 Preferred ratings and characteristics 15-9:2003

The values given in detail specifications shall preferably be selected from the following:

2.1.1 Preferred climatic categories

The surface mount resistor networks covered by this specification are classified into climatic categories according to the general rules given in IEC 60068-1.

The lower and upper category temperature and the duration of the damp heat, steady state shall be chosen from the following:

Lower category temperature: -55 °C, -40 °C, -25 °C and -10 °C. Upper category temperature: +85 °C, +100 °C, +125 °C and +155 °C.

Duration of the damp heat, steady state test: 4, 10, 21 and 56 days.

The severities for the cold and dry heat tests are the lower and upper category temperatures respectively. Because of the construction of some surface mount resistor networks these temperatures will occur between two of the preferred temperatures given in IEC 60068-2-1 and IEC 60068-2-2. In this event, the nearest preferred temperature within the actual temperature range of the surface mount resistor network shall be chosen for this severity.

2.1.2 Temperature coefficients and temperature characteristics of resistance

The preferred limits of change in resistance for the temperature characteristics of resistance test are given in Table 2.

Each line in the table gives the preferred temperature coefficient and corresponding temperature characteristic for 20 °C to 70 °C and limits of change in resistance for the measurement of the temperature characteristic of resistance (see 4.8 of IEC 60115-1) on the basis of category temperature ranges of 2.1.1 of this sectional specification.

Table 2 - Temperature coefficients and temperature characteristics of resistance

Temper- ature	ature ature		Temperature characteristic of resistance (limits of percentage change in resistance)								
coeffi- cient	charac- teristic 20/70 °C	Reference	Reference temperature /lower category temperature			Reference temperature /upper category temperature					
10 ⁻⁶ /K	%	+20/-55	+20/-40	+20/–25	+20/–10	+20/+85	+20/+100	+20/+125	+20/+155		
±500	±2,5	±3,75	±3	±2,25	1,500	±3,25	±4	±5,25	±6,75		
±250	±1,25	±1,88	±1,5	±1,13	0,750	±1,62	±2	±2,62	±3,38		
±100	±0,5	±0,75	±0,6	±0,45	0,300	±0,65	±0,8	±1,05	±1,35		
±50	±0,25	±0,375	±0,3	±0,23	0,150	±0,325	±0,4	±0,525	±0,675		
±25	±0,125	±0,188	±0,15	±0,113	0,075	±0,162	±0,2	±0,262	±0,338		
±15	±0,075	±0,113	±0,09	±0,068	0,045	±0,098	±0,12	±0,158	±0,203		
±10	±0,05	±0,075	±0,06	±0,045	0,030	±0,065	±0,08	±0,105	±0,135		

NOTE 1 Resistors having an upper category temperature of +85 °C need not be measured between 20 °C and 70 °C.

NOTE 2 If measurements are required at additional temperatures, these shall be specified in the detail specification.

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2.1.3 Limits for change din resistance/standards/sist/34021bb0-6f6f-4c36-830f-

e1db3cf00644/iec-60115-9-2003

For each stability class the preferred limits for change in resistance for each of the tests listed in the heading of Table 3 are as indicated.

Table 3 - Limits for change in resistance

		Long-term tests		Short-term tests		
Stability class	4.23	Climatic sequence	4.13	Overload		
in %	4.24	Damp heat, steady state	4.18	Resistance to soldering heat		
	4.25.1	Endurance at 70 °C	4.19	Rapid change of temperature		
4.25.3	Endurance at upper category	4.32	Shear			
		temperature	4.33	Substrate bending test		
5		±(5 % +0,1 Ω)		±(1 % +0,05 Ω)		
3		$\pm (3 \% +0.1 \Omega)$		$\pm (0.5 \% +0.05 \Omega)$		
2		\pm (2 % +0,1 Ω)		$\pm (0.5~\%~+0.05~\Omega)$		
1		±(1 % +0,05 Ω)		±(0,25 %+0,05 Ω)		
0,5		$\pm (0.5 \% +0.05 \Omega)$		±(0,1 % +0,01 Ω)		
0,25		$\pm (0.25 \% + 0.05 \Omega)$		$\pm (0.05~\% + 0.01~\Omega)$		
0,1		±(0,1 % +0,01 Ω)		±(0,02 %+0,01 Ω)		

2.2 Preferred values of ratings

2.2.1 Rated resistance

See 2.2.6 of IEC 60115-1.

2.2.2 Tolerances on rated resistance

The preferred tolerances on rated resistance are:

 ± 5 %; ± 2 %; ± 1 %; ± 0.5 %; ± 0.25 % and ± 0.1 %.

2.2.3 Rated dissipation (in the mounted state)

The preferred values of rated dissipation, at 70 °C, are:

For the network: 0,125 W; 0,25 W and 0,5 W.

For the resistor element: 0,03 W; 0,05 W; 0,063 W; 0,1 W and 0,125 W.

The detail specification shall prescribe the applicable value of rated dissipation for each resistor element in the network and also the maximum allowable total dissipation for the network.

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The derated values of dissipation at temperatures in excess of 70 °C shall be as indicated by the curve in Figure 1: (Standards.iteh.ai)

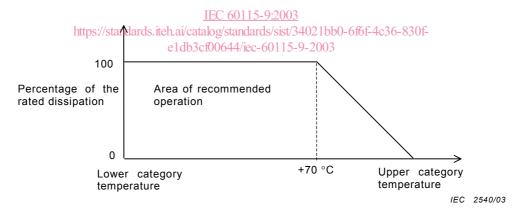


Figure 1 - Rated dissipation curve

A larger area of operation may be given in the detail specification, provided it includes all of the area given above. In this event, the detail specification shall state the maximum allowable dissipation at temperatures other than 70 $^{\circ}$ C. All break points on the curve shall be verified by test.

2.2.4 Limiting element voltage

The preferred values of limiting element voltage are:

25 V; 50 V; 100 V and 200 V DC or AC r.m.s.

2.2.5 Insulation resistance (if applicable)

The insulation resistance shall be not less than 1 G Ω after dry heat tests.

2.2.6 Insulation resistance between individual resistors (if applicable)

The preferred minimum limit for insulation resistance between individual resistors shall be 100 M Ω unless otherwise prescribed in the detail specification.

2.2.7 Insulation voltage against conducting mounting surface

The maximum DC or AC r.m.s. voltage which can be applied under continuous operating conditions between the resistor network terminations and any conducting mounting surface shall be prescribed in the relevant detail specification.

2.2.8 Insulation voltage between neighbouring individual resistors

The maximum DC or AC r.m.s. voltage which can be applied under continuous operating conditions between each individual resistor element as one pole, and all other individual resistors connected together as the other pole shall be prescribed in the relevant detail specification.

2.3 Preferred test severities

Test severities given in detail specifications shall preferably be selected from the following:

2.3.1 Drying

Procedure I of 4.3 of IEC 60115-1 shall be used PREVIEW

Overload (in the mounted state) and siteh ai) 2.3.2

4.13 of IEC 60115-1, with the following details:

http://standards.iteh.ai/catalog/tandards/sist/34021bb0-6fff-4c3fi-830fg element voltage, whichever is the less. Applied voltage:

Duration: the DC test voltage shall be applied for 2 s to each resistor in the

network, one at a time.

Substrate material: epoxy glass laminate as specified in the detail specification.

The distance between surface mount resistor networks shall not be less than the largest dimension of the surface mount resistor network. The detail specification shall specify any further details as necessary (see 2.2.3).

Quality assessment procedures

3.1 Structurally similar components

Surface mount resistor networks are considered as being structurally similar if they are produced with similar processes and materials, and have the same nominal dimensions but different resistance values and temperature characteristics.

3.2 **Qualification approval**

The procedures for Qualification Approval testing are given in 3.5 of IEC 60115-1.

The schedule to be used for Qualification Approval testing on the basis of lot-by-lot and periodic testing is given in 3.3 of this specification. The procedure using a fixed sample size schedule is given in 3.2.1 and 3.2.2.